

## NPN Silicon AF and Switching Transistor

- For general AF applications
- High breakdown voltage
- Low collector-emitter saturation voltage
- Complementary type: BCX42 (PNP)
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101



| Type  | Marking | Pin Configuration |       |       | Package |
|-------|---------|-------------------|-------|-------|---------|
| BCX41 | EKs     | 1 = B             | 2 = E | 3 = C | SOT23   |

### Maximum Ratings

| Parameter                                   | Symbol    | Value       | Unit |
|---------------------------------------------|-----------|-------------|------|
| Collector-emitter voltage                   | $V_{CEO}$ | 125         | V    |
| Collector-base voltage                      | $V_{CBO}$ | 125         |      |
| Emitter-base voltage                        | $V_{EBO}$ | 5           |      |
| Collector current                           | $I_C$     | 800         | mA   |
| Peak collector current, $t_p \leq 10$ ms    | $I_{CM}$  | 1           | A    |
| Base current                                | $I_B$     | 100         | mA   |
| Peak base current                           | $I_{BM}$  | 200         |      |
| Total power dissipation<br>$T_S \leq 79$ °C | $P_{tot}$ | 330         | mW   |
| Junction temperature                        | $T_j$     | 150         | °C   |
| Storage temperature                         | $T_{stg}$ | -65 ... 150 |      |

### Thermal Resistance

| Parameter                                | Symbol     | Value      | Unit |
|------------------------------------------|------------|------------|------|
| Junction - soldering point <sup>1)</sup> | $R_{thJS}$ | $\leq 215$ | K/W  |

<sup>1)</sup>For calculation of  $R_{thJA}$  please refer to Application Note AN077 (Thermal Resistance Calculation)

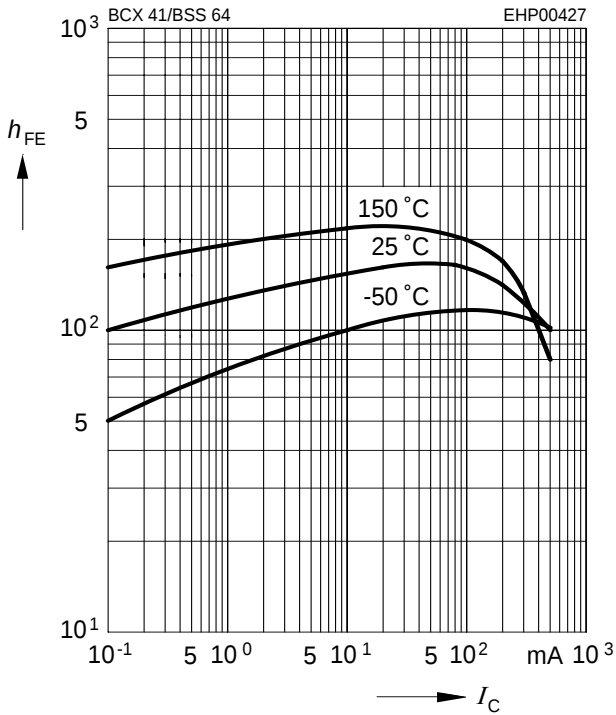
**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

| Parameter                                                                                                                                                                        | Symbol        | Values         |             |             | Unit          |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------|----------------|-------------|-------------|---------------|
|                                                                                                                                                                                  |               | min.           | typ.        | max.        |               |
| DC Characteristics                                                                                                                                                               |               |                |             |             |               |
| Collector-emitter breakdown voltage<br>$I_C = 10\text{ mA}, I_B = 0$                                                                                                             | $V_{(BR)CEO}$ | 125            | -           | -           | V             |
| Collector-base breakdown voltage<br>$I_C = 100\text{ }\mu\text{A}, I_E = 0$                                                                                                      | $V_{(BR)CBO}$ | 125            | -           | -           |               |
| Emitter-base breakdown voltage<br>$I_E = 10\text{ }\mu\text{A}, I_C = 0$                                                                                                         | $V_{(BR)EBO}$ | 5              | -           | -           |               |
| Collector-base cutoff current<br>$V_{CB} = 100\text{ V}, I_E = 0$<br>$V_{CB} = 100\text{ V}, I_E = 0, T_A = 150\text{ }^\circ\text{C}$                                           | $I_{CBO}$     | -<br>-         | -<br>-      | 0.1<br>20   | $\mu\text{A}$ |
| Collector-emitter cutoff current<br>$V_{CE} = 100\text{ V}, T_A = 85\text{ }^\circ\text{C}$<br>$V_{CE} = 100\text{ V}, T_A = 125\text{ }^\circ\text{C}$                          | $I_{CEO}$     | -<br>-         | -<br>-      | 10<br>75    |               |
| Emitter-base cutoff current<br>$V_{EB} = 4\text{ V}, I_C = 0$                                                                                                                    | $I_{EBO}$     | -              | -           | 100         | nA            |
| DC current gain <sup>1)</sup><br>$I_C = 100\text{ }\mu\text{A}, V_{CE} = 1\text{ V}$<br>$I_C = 100\text{ mA}, V_{CE} = 1\text{ V}$<br>$I_C = 200\text{ mA}, V_{CE} = 1\text{ V}$ | $h_{FE}$      | 25<br>63<br>40 | -<br>-<br>- | -<br>-<br>- | -             |
| Collector-emitter saturation voltage <sup>1)</sup><br>$I_C = 300\text{ mA}, I_B = 30\text{ mA}$                                                                                  | $V_{CEsat}$   | -              | -           | 0.9         | V             |
| Base emitter saturation voltage <sup>1)</sup><br>$I_C = 300\text{ mA}, I_B = 30\text{ mA}$                                                                                       | $V_{BEsat}$   | -              | -           | 1.4         |               |
| AC Characteristics                                                                                                                                                               |               |                |             |             |               |
| Transition frequency<br>$I_C = 20\text{ mA}, V_{CE} = 5\text{ V}, f = 20\text{ MHz}$                                                                                             | $f_T$         | -              | 100         | -           | MHz           |
| Collector-base capacitance<br>$V_{CB} = 10\text{ V}, f = 1\text{ MHz}$                                                                                                           | $C_{cb}$      | -              | 12          | -           | pF            |

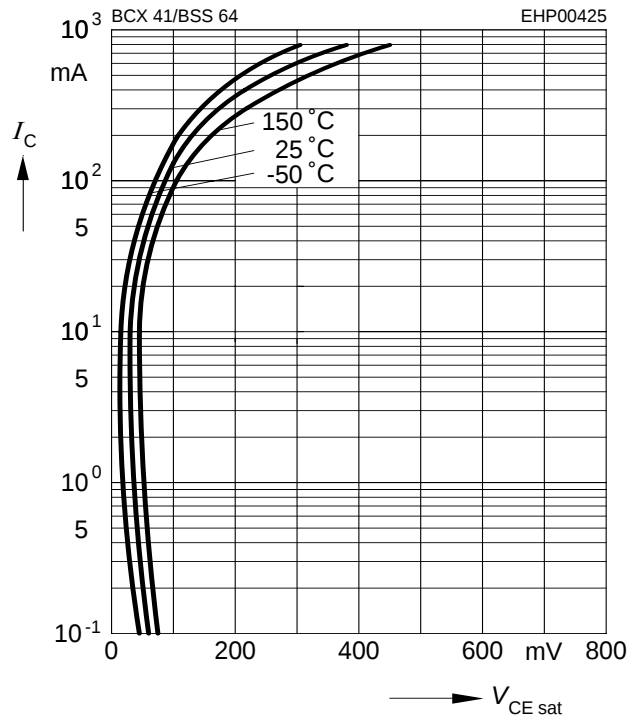
<sup>1)</sup>Pulse test:  $t < 300\mu\text{s}$ ;  $D < 2\%$

**DC current gain  $h_{FE} = f(I_C)$** 

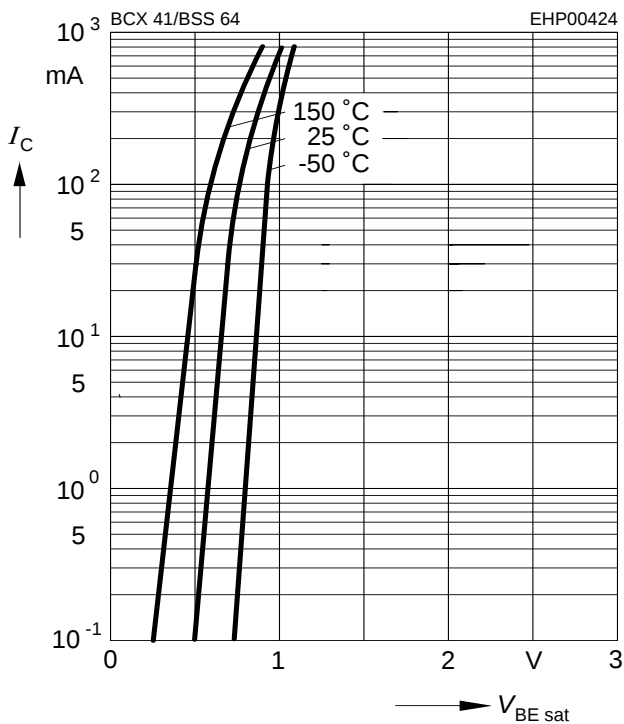
$$V_{CE} = 1 \text{ V}$$


**Collector-emitter saturation voltage**

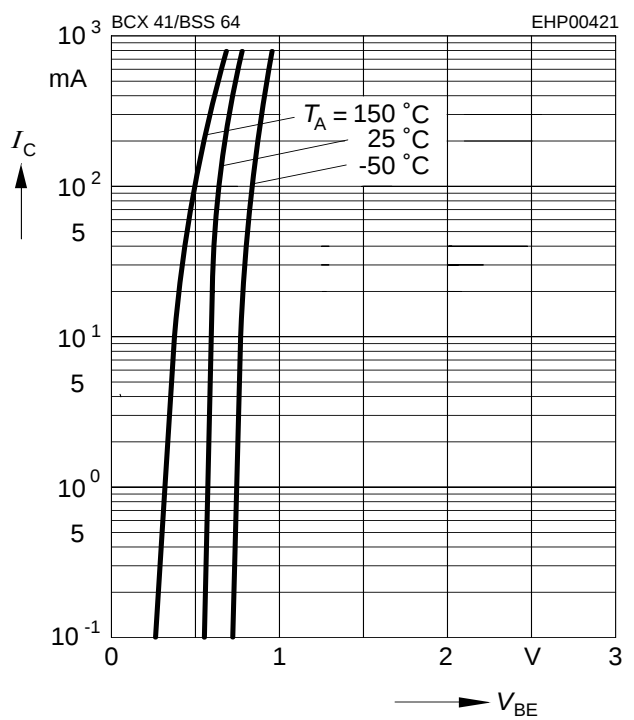
$$I_C = f(V_{CEsat}), h_{FE} = 10$$


**Base-emitter saturation voltage**

$$I_C = f(V_{BEsat}), h_{FE} = 10$$

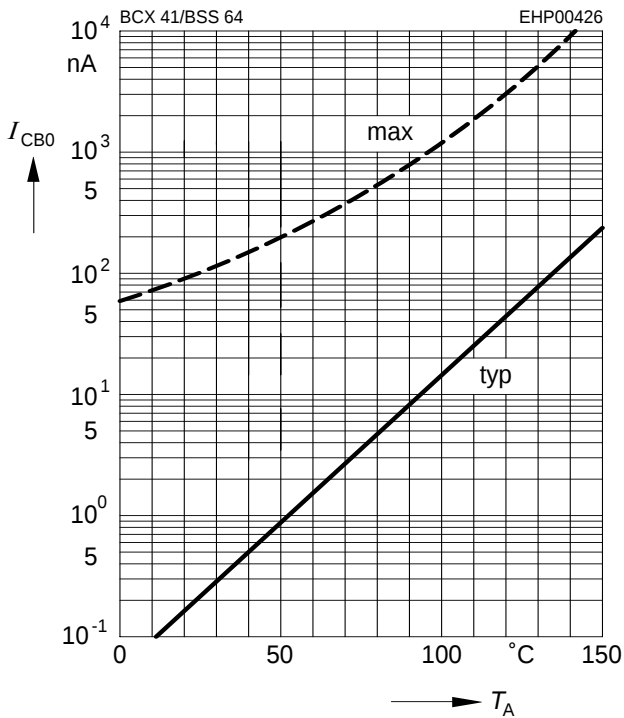

**Collector current  $I_C = f(V_{BE})$** 

$$V_{CE} = 1 \text{ V}$$



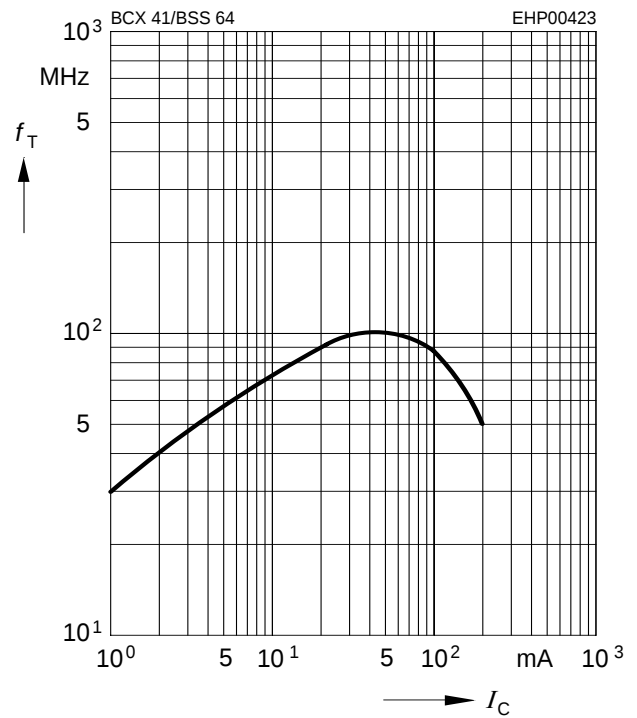
**Collector cutoff current**  $I_{CBO} = f(T_A)$

$V_{CBO} = 80 \text{ V}$



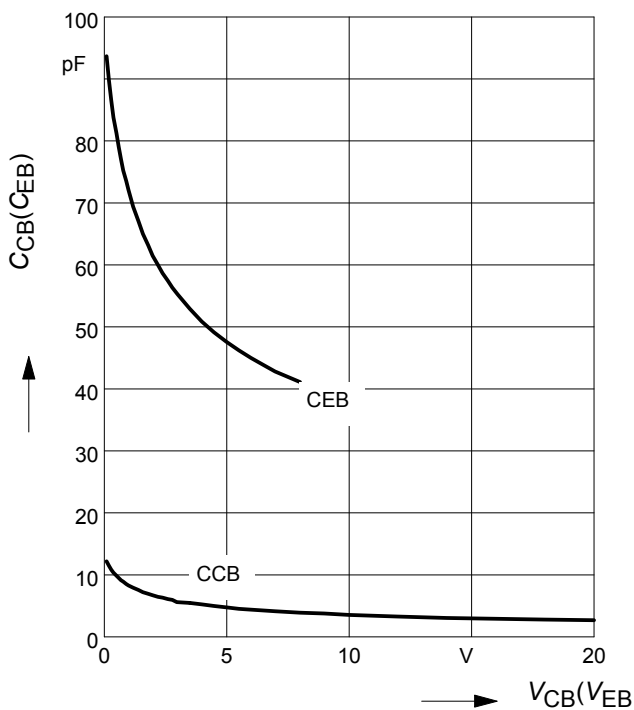
**Transition frequency**  $f_T = f(I_C)$

$V_{CE} = 5 \text{ V}$

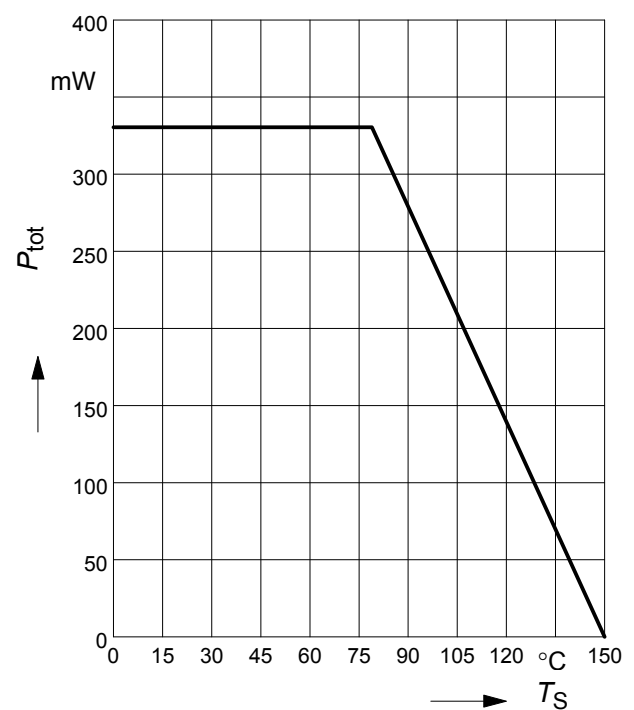


**Collector-base capacitance**  $C_{cb} = f(V_{CB})$

**Emitter-base capacitance**  $C_{eb} = f(V_{EB})$

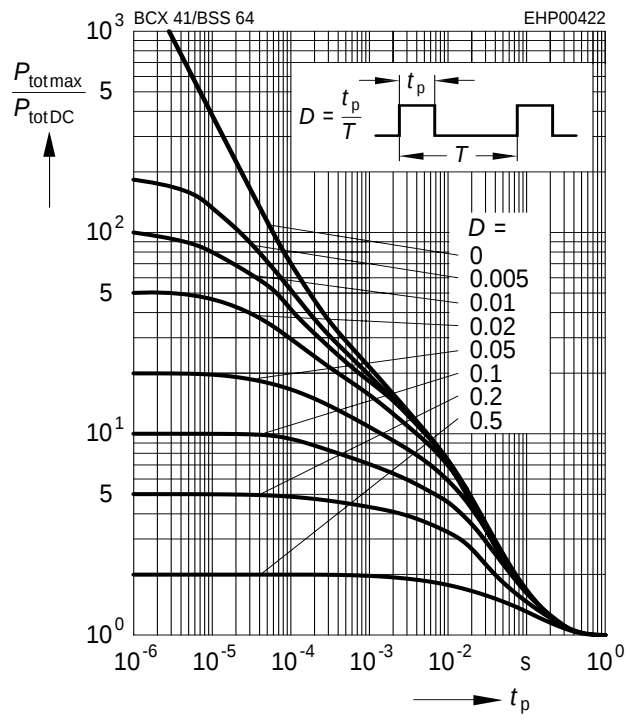


**Total power dissipation**  $P_{tot} = f(T_S)$



## Permissible Pulse Load

$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$$

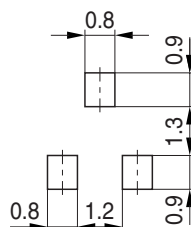


## Package Outline

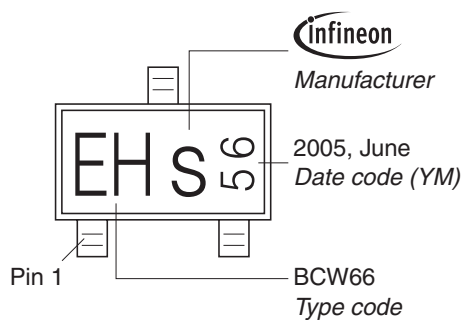


1) Lead width can be 0.6 max. in dambar area

## Foot Print



## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel



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